

Conference Calendar

January 1989

- 15-18 **Composites and Advanced Ceramics**,
13th Annu. Conf.
Cocoa Beach (USA)
Contact: The American Ceramic Soc., 757 Brooksedge Plaza Dr., Westerville, OH 43081-6136, USA
- 15-20 **Optics, Electro-Optics, and Laser Applications in Sci. and Eng.**,
Symp. and Exhibition
Los Angeles (USA)
Contact: Soc. of Photo-Optical Instrumentation Eng. (SPIE), P.O. Box 10, Bellingham, WA 98227, USA
- 17-19 **Optical Data Storage**
Top. Mtg.
Los Angeles (USA)
Contact: Optical Soc. of America (OSA), 1816 Jefferson Pl. NW, Washington, DC 20036, USA
- 19 **Electron Beam Testing of Integrated Circuits**
London (United Kingdom)
Contact: Meetings Officer, Inst. of Physics, 47 Belgrave Sq., London SW1X 8QX, UK
- 23-24 **Commercial Applications of Superconductivity**,
2nd Annu. Cambridge Conf.
Boston (USA)
Contact: World Tech. Press, 1 Kendall Sq., Suite 2200, Cambridge, MA 02139, USA
- 31-3 **Polymer**,
17th Australian Symp.
Brisbane (Australien)
Contact: Dr. D. J. T. Hill, Chem. Dept., Univ. of Queensland, Brisbane 4067, Australia
- 31-3 **Sintering of Multiphase Metal and Ceramic Systems**
Int. Conf.
New Delhi (India)
Contact: G. S. Upadhyaya, Convener ICSMC '89, Dept. of Metallurgical Eng., Indian Inst. of Technol., Kanpur 208 016, India

February 1989

- 2 **Silicon Molecular Beam Epitaxy**
E-MRS Spring Mtg.
Strasbourg (France)
Contact: E. Kasper, AEG-Forschungszentrum, Sedanstr. 10, D-7900 Ulm, FRG
- 2-4 **Nonlinear Guided Wave Phenomena: Physics and Applications**,
Top. Mtg.
Houston (USA)
Contact: Optical Soc. of America (OSA), 1816 Jefferson Pl. NW, Washington, DC 20036, USA
- 5-9 **Biomedical Polymers**,
Int. Symp.
Perth (Australia)
Contact: Secretary, W. A. Polymer Group, Royal Australian Chemical Inst., 125 Hay St., Perth, W. A. 6000, Australia
- 6-10 **Composites**,
SPI Inst. Annu. Conf.
Dallas (USA)
Contact: Composites Inst., SPI, 355 Lexington Ave., New York, NY 10017, USA
- 6-9 **Optical Fiber Communication**,
IEEE-LEOS-OSA Conf. (OFC '89 and IGWO '89)
Houston (USA)
Contact: Optical Soc. of America (OSA), 1816 Jefferson Pl. NW, Washington, DC 20036, USA
- 7-9 **Physics and Chemistry of Semiconductor Interfaces (PCSI-6)**
Bozeman (USA)
Contact: G. J. Lapeyre, Physics Dept., Montana State Univ., Bozeman, MT 59717, USA
- 12-15 **High-Resolution Optical FT Spectrometry and Noninvasive Assessment of Visual Systems**,
Top. Mtgs.
Santa Fe (USA)
Contact: Optical Soc. of America (OSA), 1816 Jefferson Pl.

NW, Washington, DC 20036, USA

- 13-17 **Plasma Processing in Semiconductor Materials**
Bristol (United Kingdom)
Contact: Dr. S. Pringle, Dept. of Extramural Studies, The Univ., Queens Rd., Bristol BS8 1HR, UK
- 19-22 **Adhesion**,
12th. Annu. Mtg.
Hilton Head Island (USA)
Contact: D. Hunston, NBS, Polym. Div., Gaithersburg, MD 20899, USA
- 21-24 **Recent Advances in Drug Delivery**
Salt Lake City (USA)
Contact: K. Knutson, Univ. of Utah, Dept. of Pharmaceuticals, CCCD, 421 Wakara Way, Suite 318, Salt Lake City, UT 84108, USA
- 21-26 **Optical Fibers and their Applications**,
5th Symp.
Warsaw (Poland)
Contact: R. S. Romaniuk, IPI Warsaw Univ. of Technol., Nowowiepska 15-19, PL-00-665, Warsaw, Poland
- 26-3 **Microolithography**,
Symp. and Exhibition (Micro '89)
Santa Clara (USA)
Contact: Soc. of Photo-Optical Instrumentation Eng. (SPIE), P.O. Box 10, Bellingham, WA 98227, USA
- 27-1 **Microphysics of Surfaces, Beams and Adsorbates**,
3rd Top. Mtg.
Salt Lake City (USA)
Contact: R. B. Hall, Exxon Research & Eng., Rt. 22E, Annandale, NJ 08801, USA
- 27-3 **Superconductivity**,
Gordon Conf.
West Coast (USA)
Contact: A. Sleight, E. I. Du Pont de Nemours, Experimental Station 356/301, Wilmington, DE 19898, USA

27-3 **High-Temperature Superconducting Oxides: Processing & Related Properties**, TMS Annu. Mtg. Las Vegas (USA)
Contact: M. Karl, The Metallurgical Soc., 420 Commonwealth Drive, Warrendale, PA 15086, USA

March 1989

1-3 **Technical Ceramics**, 2nd Int. Congr. and Exhibition (Techkeram 2) Wiesbaden (Fed. Rep. Germany)
Contact: Demat Exposition Managing, P.O. Box 110611, D-6000 Frankfurt, FRG

5-10 **Liquid Crystals**, 6th Eur. Winter Conf. Schlading (Austria)
Contact: P. Laggner, Inst. für Röntgenfeinstrukturforschung of the Austrian Academy of Sci., Steyrergasse 17, A-8010 Graz, Austria

6-8 **Crystal Structure, Microstructure and Properties of Minerals and Ceramic Materials**, Int. Colloq. Bochum (Fed. Rep. Germany)
Contact: Prof. O. W. Flörke, Ruhr-Univ. Bochum, Inst. für Mineralogie, P.O. Box 102148, D-4630 Bochum, FRG

6-8 **Lithium Battery Technology & Applications**, 4th Int. Seminar Deerfield Beach (USA)
Contact: S. P. Wolsky, Ansum Enterprises Inc., 950 De Soto Rd., Suite 3B, Boca Raton, FL 33432, USA

6-9 **Condensed Matter Division**, 9th Gen. Conf. Nice (France)
Contact: Dr. F. Raymond CNRS-Bât. 3, rue Albert Einstein, F-06560 Valbonne, France

6-9 **Advanced Materials**, MRS Industry-Univ. Conf. Denver (USA)
Contact: Dr. Fred Smith, Adv.

Mater. Inst., Colorado School of Mines, 1500 Illinois, Golden, CO 80401, USA

6-10 **Quantum Wells for Optics and Optoelectronics; Picosecond Electronics and Optoelectronics**, Top. Mtg. Salt Lake City (USA)
Contact: Optical Soc. of America (OSA), 1816 Jefferson Pl. NW, Washington, DC 20036, USA

8-9 **Molecular Chemistry of Solid-State Electronics** London (United Kingdom)
Contact: The Royal Society, 6 Carlton House Terrace, London SW1Y 5AG, UK

9-11 **Makromolekulares Kolloquium** Freiburg (Fed. Rep. Germany)
Contact: Prof. H. Finkelmann, Inst. für Makromol. Chemie der Univ., Stefan-Meier-Str. 31, D-7800 Freiburg, FRG

11-14 **Surface Finishing '89** Brighton (United Kingdom)
Contact: Inst. of Metal Finishing, Exeter House, 48 Holloway Head, Birmingham B1 1NQ, UK

12-14 **High-Tech-Materials and Finishing** Berlin (West)
Contact: Technik + Kommunikation-Verlag GmbH, Ritterfelddamm 82 h + i, D-1000 Berlin 22

12-25 **Diffusion in Materials**, NATO Adv. Study Inst. Aussois (France)
Contact: A. L. Laskar, Phys. and Astron. Dept., Clemson Univ., Clemson, SC 29631, USA

13-14 **Regio Macro II** Basel (Switzerland)
Contact: Prof. M. Mutter, Inst. für Org. Chem., Univ. Basel, St. Johannis-Ring 19, CH-4056 Basel, Switzerland

15-17 **Confocal Microscopy/3-D Image Processing in Microscopy**, 1st Int. Conf./2nd Int. Conf. Amsterdam (Netherlands)
Contact: Bureau PAOG, Congr. Office, Tafelbergweg 25, NL-1105 BC, Amsterdam, Netherlands

15-17 **Intelligent Materials**, Int. Workshop Ibaraki (Japan)
Contact: T. Kurino, The Soc. of Nontraditional Technol., Toranomon Kotohira-Kaikan Bldg. 3F, 1-2-8 Toranomon, Minato-ku, Tokyo 105, Japan

20-22 **Mechanical Properties of Materials at High Rates of Strain**, 4th Int. Conf. Oxford (United Kingdom)
Contact: J. Harding, Eng. Sci. Dept., Univ. of Oxford, Parks Rd., Oxford OX1 3PJ, UK

20-22 **Refractory Metals and Silicides** Eur. Workshop Houthalen (Belgium)
Contact: R. De Keersmaecker, IMBE, Kapeldreef 75, B-3030 Leuven, Belgium

20-23 **Surface Science**, Interdisciplinary Conf. Liverpool (United Kingdom)
Contact: P. Weightman, Liverpool Univ., Oliver Lodge Lab., Oxford St., P.O. Box 147, Liverpool L69 3BX, UK

27-31 **Aerospace Sensing**, Tech. SPIE's Symp. Orlando (USA)
Contact: Soc. of Photo-Optical Instrumentation Eng. (SPIE), Technical Program Committee, P.O. Box 10, Bellingham, WA 98227, USA

28-31 **Aluminum-Lithium**, 5th Int. Conf. Williamsburg (USA)
Contact: Al-Li-V, School of Eng. and Applied Sci., Thornton Hall, Univ. of Virginia, Charlottesville, VA 22901, USA

29-31 **Neutron and X-Ray Scattering: Complementary Techniques** Canterbury (United Kingdom)
Contact: Dr. R. J. Newport, Univ. of Kent, Physics Dept., Canterbury, Kent CT2 7NR, UK

30-31 **Colorado Microelectronics** Colorado Springs (USA)
Contact: CMC '89 Conf. Secretary, Microelectronics Research Lab., Univ. of Colorado, Colorado Springs, CO 80933-7150, USA

30-14 **High-T_c Superconductors**,
Exp. Workshop
Miramare (Italy)
Contact: Int. Ctr. for Theoretical Physics, P.O. Box 586,
I-34100 Trieste, Italy

April 1989

1-6 **Superconductivity**,
2nd World Congr.
Houston (USA)
Contact: R. D. Kane, World
Congr. on Superconductivity,
P.O. Box 27805, Houston,
TX 77227-7805, USA

3-5 **Modern Practice in Stress and
Vibration Analysis**
Liverpool (United Kingdom)
Contact: Meetings Officer,
Inst. of Physics, 47 Belgrave
Sq., London SW1X 8QX, UK

3-6 **Low Energy Ion Beams**,
5th Conf.
Guildford (United Kingdom)
Contact: Meetings Officer,
Inst. of Physics, 47 Belgrave
Sq., London SW1X 8QX, UK

3-7 **Copolymerization and Co-
polymers in Dispersed Media**
Lyon (France)
Contact: I. Guillot/C. Pichot,
Lab. des Matériaux Organiques,
BP 24, F-69390
Vernaison, France

3-7 **High Temperature Materials '89**
Gaithersburg (USA)
Contact: J. W. Hastie,
National Bureau of Standards,
Gaithersburg, MD 20899, USA

4-14 **Phase Transition in Soft
Condensed Matter**,
NATO Adv. Study Inst.
Geilo (Norwegen)
Contact: G. Jarret, Inst. for
Energy Technol., Dept. of
Physics, P.O. Box 40, N-2007
Kjeller, Norway

6-7 **Modeling in Crystal Growth
from the Melt**,
NATO Workshop
Parma (Italy)
Contact: G. Müller, Inst. für
Werkstoffwissenschaften 6,
Martensstraße 7, D-8520
Erlangen, FRG

10-12 **Bayreuther Polymer Symp.**,
(BPS '89)
Bayreuth (Fed. Rep. Germany)
Contact: BPS '89, Lehrstuhl
Makromolekulare Chemie II,
Univ. Bayreuth, Postfach
101251, D-8580 Bayreuth,
FRG

10-13 **Microscopy of Semiconducting
Materials**,
MRS 6th Oxford Conf.
Oxford (United Kingdom)
Contact: Administrator, Royal
Microscopy Soc., 37/38 St.
Clements, Oxford OX4 1AJ,
UK

11-13 **Catalysis by Well Character-
ized Materials**
Liverpool (United Kingdom)
Contact: Prof. R. W. Joyner,
Leverhulme Ctr. for Innovative
Catalysts, Univ. of Liverpool,
Grove St., P.O. Box 147,
Liverpool L69 3BX, UK

17-26 **Ceramics and Composite
Materials**,
Spring College in Mater. Sci.
Trieste (Italy)
Contact: Int. Ctr. for Theoretical Physics, Spring College
in Mater. Sci. 1989,
P.O. Box 586, I-34100 Trieste,
Italy

18-19 **Industrial Water-Soluble and
Water-Swellable Polymers**
Manchester (United Kingdom)
Contact: The Registrar (Mid-
Career Training), UMIST,
P.O. Box 88, Manchester
M60 1QD, UK

23-28 **Nondestructive Testing**,
12th World Conf.
(WCNDT '89)
Amsterdam (Netherlands)
Contact: B. de Jong, RAI Or-
ganisatie Bureau Amsterdam
bv, Europaplein 12, 1078 GZ
Amsterdam, Netherlands

23-27 **American Ceramic Society**,
91st Annu. Mtg. and Expo.
Indianapolis (USA)
Contact: Dr. K. M. Nair,
Electronics Dept., E.I. du
Pont de Nemours Co., Inc.,
3181 Buffalo Ave., Niagara
Falls, NY 14302, USA

24-28 **Optical Science and
Engineering**,
2nd Int. Congr.

Paris (France)
Contact: Soc. of Photo-Optical
Instrumentation Eng. (SPIE),
P.O. Box 10, Bellingham,
WA 98227, USA

24-28 **Lasers and Electro-Optics**,
LEOS-IEEE-OSA Conf.
(CLEO '89)
Baltimore (USA)
Contact: Optical Soc. of America (OSA), 1816 Jefferson Pl.
NW, Washington, DC 20036,
USA

24-28 **MRS-Spring Mtg.**
San Diego (USA)
Contact: J. B. Ballance, MRS,
9800 McKnight Rd., Suite
327, Pittsburgh, PA 15237,
USA

25-27 **Hot Isostatic Pressing of
Materials**
Antwerpen (Belgium)
Contact: Hot Isostatic Pressing
Conf., c/o K. VIV, Jan van
Rijswijklaan 58,
B-2018 Antwerpen, Belgium

26-28 **Joining Ceramics, Glass and
Metal**
3rd Int. Conf. (CGM '89)
Contact: Dtsch. Gesellsch.
Metallkd., Adenauerallee 21,
D-6370 Oberursel, FRG

May 1989

1-3 **Tunable Solid State Lasers**,
Top. Mtg.
North Falmouth (USA)
Contact: Optical Soc. of America (OSA), 1816 Jefferson Pl.
NW, Washington, DC 20036,
USA

1-5 **Scanning Microscopy**,
Salt Lake City (USA)
Contact: O. Johari, Scanning
Microscopy Int., P.O. Box
66507, Chicago, IL 60666,
USA

4-6 **The Solid State—Dynamics
and Kinetics**
Annu. Mtg. Dtsch. Bunsen-
Gesellsch. für Phys. Chem.
Siegen (Fed. Rep. Germany)
Contact: Dtsch. Bunsen-Ge-
sellsch., Carl-Bosch-Haus,
Varrentrappstr. 40/42, D-6000
Frankfurt am Main 90, FRG

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| <p>7-12 High-<i>T_c</i> Superconductor Technologies
175th Mtg. Electrochem. Soc. Los Angeles (USA)
Contact: S. Raider, IBM T. J. Watson Research Ctr., P.O. Box 218, York Town Heights, NY 10598, USA</p> <p>8-12 High Temperature and Wear Resistant Materials in a World of Changing Technology
12th Int. Plansee Seminar Plansee (Austria)
Contact: Metallwerk Plansee, A-6600 Reutte, Austria</p> <p>9-11 Coatings and Sensors for Acoustic and Electromagnetic-Optical Applications
Univ. Park (USA)
Contact: V. K. Varadan, Dept. of Eng. Sci. and Mechanics, Penn. State Univ., 227 Hammond Bldg., Univ. Park, PA 16802, USA</p> <p>10-11 Polyimides
Montpellier (France)
Contact: Prof. M. Abadie, LEMD/MAO-USTL, F-34060 Montpellier Cedex 1, France</p> <p>16-19 Modern Developments in Materials Science and Technology
Annu. Mtg. Dtsch. Gesellsch. Metallkd. Karlsruhe (Fed. Rep. Germany)
Contact: Dtsch. Gesellsch. Metallkd., Adenauerallee 21, D-6370 Oberursel, FRG</p> <p>22-24 Werkstoffanalytik, Wien (Austria)
Contact: Prof. Dr. M. Graserbauer, Inst. für Analytische Chem. der Tech. Univ. Wien, Getreidemarkt 9, A-1060 Wien, Austria</p> <p>22-24 Glastechnische Tagung
Stuttgart (Fed. Rep. Germany)
Contact: Dtsch. Glastechn. Gesellsch., Mendelssohnstr. 75-77, D-6000 Frankfurt am Main, FRG</p> <p>22-25 Graphite Intercalation Compounds, 5th Int. Symp. (ISGIC-5) Berlin (West)</p> | <p>24-26 Advances in the Stabilization and Controlled Degradation of Polymers, 11th Int. Conf. Luzern (Switzerland)
Contact: Dr. A. V. Patsis, Inst. in Materials Sci, State Univ. of New York, New Paltz, NY 12561, USA</p> <p>25-26 Quantitative Methods in Assessment of Structural Defects
Kansas City (USA)
Contact: A. P. Berens, Univ. of Dayton, Research Inst., 300 College Park Ave., Dayton, OH 45469, USA</p> <p>29-31 Cross-linked Polymers, 3rd Int. Conf. Luzern (Switzerland)
Contact: Dr. A. V. Patsis, Inst. in Materials Sci, State Univ. of New York, New Paltz, NY 12561, USA</p> <p>29-2 Molecular Beams
Perugia (Italy)
Contact: V. Aquilanti, Univ. di Perugia, Dipt. di Chimica, I-06100 Perugia, Italy</p> <p>31-2 Applied Surface Analysis, 11th Symp. Cleveland (USA)
Contact: J. Grant, Research Inst., 300 College Park, Dayton, OH 45469-0001, USA</p> <p>31-2 Thermogravimetry and Thermal Engineering, 6th Biennial Conf. Budapest (Hungary)
Contact: I. Benko, MATE, House of Technol. III. 318, P.O. Box 451, H-1372 Budapest, Hungary</p> | <p>12-14 Rubber, Int. Conf. 90 IRC Exhibition Paris (France)
Contact: Soc. de Chimie Industrielle, 28, rue Saint-Dominique, F-75007 Paris, France</p> <p>12-15 Narrow-Gap Semiconductors and Related Materials, Int. Conf. Ogunquit (USA)
Contact: D. G. Seiler, Phys. Dept., Univ. of North Texas, P.O. Box 5368, Denton, TX 76203, USA</p> <p>18-21 Colloid & Surface Science, 63rd ACS Div. of Colloid & Surface Chem. Symp. Seattle (USA)
Contact: J. Berg, Dept. of Chemical Eng. BF-10, Univ. of Washington, Seattle, WA 98105, USA</p> <p>19-21 SAMPE-Electronics, 3rd Int. Conf. Los Angeles (USA)
Contact: M. Smith, Business Director, SAMPE, P.O. Box 2459, Covina, CA 91722, USA</p> <p>21-23 Chemically Modified Surfaces, Midland (USA)
Contact: W. T. Collins, Dow Corning Corp., Mail Stop C41C00, Midland, MI 48686, USA</p> <p>22-25 Optics Asia '89
Singapore (Singapore)
Contact: Asia '89, 994 Bende-meer Rd., N° 04-03, Singapore 1233, Singapore</p> <p>25-30 Solid State Sensors and Actuators (Transducers -5)/ Eurosensors III
Montreux (Switzerland)
Contact: COMST S.A., P.O. Box 415, CH-1001 Lausanne 1, Switzerland</p> <p>26-28 Molecular Design of Functional Polymers, IUPAC Int. Symp. Seoul (Korea)
Contact: IUPAC Int. Symp., c/o Polymer Soc. of Korea, Rm. 601, Hyecheon Bldg., 831 Yeoksam-dong, Kangnam-ku, Seoul 135-792, Korea</p> |
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June 1989

- 6-9 **Chemistry of Functional Dyes**, Int. Symp. (ESTech '89) Osaka (Japan)
Contact: Prof. T. Kitao, General Secretary of the Symp.,

26-30 **Solid State Chemistry**,
2nd Int. Symp.
Pardubice (Czechoslovakia)
Contact: Dr. L. Koudelka,
Inst. of Chem. Technol., Leni-
novo nam., 565, CS-53210
Pardubice, Czechoslovakia

26-30 **Supermembranes**
Trieste (Italy)
Contact: Int. Ctr. for Theo-
retical Physics, P.O. Box 586,
I-34100 Trieste, Italy

27-28 **Polymer Latex III**
London (United Kingdom)
Contact: Miss M. Peacock,
Plastics and Rubber Inst.,
11 Hobart Place,
London SW1W 0HL, UK

28-30 **Oxide Surfaces**
Midland (USA)
Contact: W. T. Collins,
Mail Stop C41C00, Dow
Corning Corp., Midland,
MI 48686-0994, USA

July 1989

2-7 **Solid State Organic Materials**,
9th Int. Conf.
Como (Italy)
Contact: Centro di Cultura
Scientifica, "A. Volta", Villa
Olmo, Via Cantoni 1, I-22100
Como, Italy

3-6 **Conduction and Breakdown in
Solid Dielectrics**
3rd Int. Conf. (ICSD '89)
Trondheim (Norway)
Contact: Prof. Sletbak, ICSD
'89, The Norwegian Inst. of
Technol., Sem Sælands V 13,
N-7034 Trondheim, Norway

4-7 **Nonlinear and Electro-optics**
Int. Conf.
Cambridge (United Kingdom)
Contact: The Meetings Officer,
The Inst. of Physics,
47 Belgrave Square,
London SW1X 8QX, UK

9-14 **Zeolites**,
8th Int. Conf.
Amsterdam (Netherlands)
Contact: M. Laboushere,
792 Keizersgracht, 1017 EC,
Amsterdam, The Netherlands

10-12 **Applied Organometallic Chem-
istry: an Entry to the New
Technology**
The Pines Resort (Australia)
Contact: Dr. A. F. Masters,
School of Chemistry, Univ.
of Sydney, Sydney, N. S. W.
2006, Australia

10-13 **Magnetic Resonance in
Polymers**,
9th Spec. Colloq. Ámpere
Prague (Czechoslovakia)
Contact: P. M. M. Secretariat,
c/o Inst. of Macromol.
Chem., Czech. Acad. of Sci.,
16206 Prague, Czechoslovakia

10-14 **Electron Spectroscopy**,
4th Int. Conf.
Honolulu (USA)
Contact: G. E. McGuire, Mi-
croelectronics Ctr. of North
Carolina, P.O. Box 12889,
Research Triangle Park,
NC 27709, USA

10-14 **Organic Coatings Science and
Technology**,
15th Int. Conf.
Athens (Greece)
Contact: Dr. A. V. Patsis,
Inst. in Materials Sci, State
Univ. of New York, New
Paltz, NY 12561, USA

11-14 **Numerical Analysis of
Semiconductor Devices and
Integrated Circuits**,
6th Int. Conf.
Dublin (Ireland)
Contact: J. J. H. Miller, Nase-
Code Conf., INCA, P.O. Box
2, Dún Laoghaire, Ireland

16-21 **Catalysis**,
Eur. Conf.
Berlin (West)
Contact: Prof. G. Ertl, Fritz-
Haber-Inst. der Max-Planck-
Gesellsch., Faradayweg 4-6,
D-1000 Berlin

17-20 **Polymer Blends**
Prague (Czechoslovakia)
Contact: P. M. M. Secretariat,
c/o Inst. of Macromol.
Chem., Czech. Acad. of Sci.,
16206 Prague, Czechoslovakia

18-20 **Polymer Chemistry: Aspects
of Radical Polymerization**
Lancaster (United Kingdom)
Contact: Dr. J. R. Ebdon,
Dept. of Chemistry,

Univ. of Lancaster,
Lancaster LA1 4YA, UK

18-21 **Integrated Optics and Optical
Fiber Communications**,
7th Int. Conf. (IOOC-7)
Kobe (Japan)
Contact: P. W. Shumate, Jr.,
Bell Communications
Research, 435 S St., Morris-
town, NJ 07960, USA

23-28 **Materials and Mechanisms of
Superconductivity: High-Tem-
perature Superconductors**,
Int. Conf. (HTSC-M²S)
Stanford (USA)
Contact: Dr. T. H. Geballe,
Dept. of Applied Phys., Stan-
ford Univ., Stanford, CA
94305, USA

24-26 **Composite Structures**,
5th Int. Conf.
Paisley (United Kingdom)
Contact: Dr. I. H. Marshall,
Dept. of Mechanical and Pro-
duction Eng., Paisley College
of Technol., High St., Paisley
PA 12BE, UK

31-2 **Biologically-Engineered
Polymers**
Cambridge (United Kingdom)
Contact: Royal Soc. of Chem-
istry, Burlington House,
London W1V 0BN, UK

August 1989

2-7 **Pure and Applied Chemistry**,
32nd IUPAC Congr.
Stockholm (Sweden)
Contact: Stockholm Con-
vention Bureau, P.O. Box 6911,
S-10239 Stockholm, Sweden

13-26 **High-T_c Superconductors**,
NATO Adv. Study Inst.
Bad Windsheim (Fed. Rep.
Germany)
Contact: R. Kossowsky, Ap-
plied Res. Lab., Pennsylvania
State Univ., P.O. Box 30,
State College, PA 16804, USA

14-17 **Shock Compression of
Condensed Matter**,
APS Top. Conf.
Albuquerque (USA)
Contact: A. Roach, MS-P 915,
Los Alamos Nat. Lab., Los
Alamos, NM 87545, USA

20-24 **Imaging Systems - 150 Years of Photography**,
Int. Symp. (ISIS '89)
Dresden (German Dem. Rep.)
Contact: Conf. Secretary,
ISIS '89, Technische Univ.
Dresden, Sektion Physik, Wis-
senschaftsbereich Photophysik,
Mommensenstr. 13, DDR-8027
Dresden, GDR

20-25 **Crystal Growth: Progress in Science and Technology**,
9th Int. Conf.
Sendai (Japan)
Contact: Prof. T. Nishinaga,
Inter Group Corp., Akasaka
Yamakatsu Bldg., 8-5-32,
Akasaka Minato-ku, Tokyo
107, Japan

21-26 **Photochemistry**,
Int. Conf.
Beijin (People's Rep. China)
Contact: Prof. S. Wu, Inst.
of Photographic Chem., Acad-
emia Sinica, Beijing, People's
Rep. China

28-31 **Dynamical Processes in Excited States of Solids**,
7th Int. Conf. (DPC '89)
Athens (USA)
Contact: DPC '89, Prof. J. E.
Rives, Dept. of Physics and
Astronomy, Univ. of Georgia,
Athens, GA 30602, USA

28-1 **Ferroelectricity**,
7th Int. Mtg. (IMF-7)
Saarbrücken (Fed. Rep.
Germany)
Contact: Dr. J. Albers, Univ.
des Saarlandes, Fachbereich
Physik, D-6600 Saarbrücken,
FRG

28-1 **Sintering**,
7th World Round Table Conf.
Herceg-Novi (Yugoslavia)
Contact: Dr. D. P. Uskoković,
Serbian Academy of Sci. and
Arts, Knez-Mihailova 35,
11000 Beograd, Yugoslavia

28-1 **X-Ray Optics and Microanalysis**,
12th Int. Congr.
Cracow (Poland)
Contact: S. Jasienska, Acad-
emy of Mining and Metallur-
gy, Inst. of Metallurgy,
30-059 Cracow, Poland

28-2 **Photochemistry for High Technology**,

Int. Summer School
Leuna-Merseburg (German
Dem. Rep.)
Contact: Prof. H.-J. Timpe,
Sektion Chemie, Technische
Hochschule für Chemie, Leu-
na-Merseburg, Genssaerstr.,
DDR-42 Merseburg, GDR

29-2 **Innovation and Perspectives in Solid Phase Synthesis**,
Int. Symp.
Oxford (United Kingdom)
Contact: R. Epton, School of
Appl. Sci., Wolverhampton
Polytech., Wolverhampton
WV1 1SB, UK

September 1989

4-8 **Electrically and Optically Active Polymers**,
21st Europhysics Conf.
Lodz (Poland)
Contact: Dr. J. Ulanski,
Polymer Inst., Tech. Univ. of
Lodz, Zwirki 36, 90-924 Lodz,
Poland

4-8 **Macromolecules 89**,
Oxford (United Kingdom)
Contact: Prof. R. Epton,
School of Appl. Sciences,
The Polytechnic, Wulfruna St.,
Wolverhampton WV1 1SB, UK

4-8 **Olefin Metathesis and Polymerization**,
8th Int. Symp.
Bayreuth (Fed. Rep. Germany)
Contact: Office ISOM 8, Lab.
für Anorg. Chem., Univ.
Bayreuth, Postfach 101251,
D-8580 Bayreuth, FRG

5-7 **Interfacial Phenomena in Composite Materials**,
Int. Conf.
Sheffield (United Kingdom)
Contact: J. Herriot, Conf. Or-
ganizer, Butterworth Scientific
Ltd., P.O. Box 63, Westbury
House, Bury St., Guildford,
Surrey GU2 5BH, UK

5-8 **Optical, Electrical and Acoustic Properties**
Kent (United Kingdom)
Contact: M. D. Shuttleworth,
Plastics and Rubber Inst.,
11 Hobart Pl.,
London SW1W 0HL, UK

6-9 **Magnetic Materials and Applications '89**
Rimini (Italy)
Contact: I. Pareti, Local Chair-
man EMMA '89, Istituto Mas-
pec CNR, Via Chiavari 18/A,
43100 Parma, Italy

10-14 **Optical Communications**,
15th Eur. Conf.
Gothenburg (Sweden)
Contact: P. A. Andrekson,
Dept. of Optoelectronics,
Chalmers Univ. of Technol.,
S-41296 Gothenburg, Sweden

11-13 **Charge Transfer in Polymeric Systems**,
RSC, Faraday Div.
Contact: Dr. J. F. Gibson,
Royal Soc. of Chemistry,
Burlington House, Piccadilly,
London W1V 0BN, UK

11-13 **Holographic Systems, Components and Applications**,
2nd Int. Conf.
Bath (United Kingdom)
Contact: Inst. of Electronic
and Radio Eng., Conf. Dept.,
Savoy Hill House, London
WC2R 0JD, UK

11-13 **Surface Analysis Techniques and Applications**
Manchester (United Kingdom)
Contact: E. Wellingham, Conf.
Secretariat, Field End House,
Bude Close, Nailsea, Bristol
BS19 2FQ, UK

13-15 **Microscopy**,
150th Anniversary Commemorative Mtg.
Oxford (United Kingdom)
Contact: Microscopical Soc.,
37-38 St. Clements,
Oxford OX4 1AJ, UK

17-22 **Defect Recognition and Image Processing in Semiconductors**,
3rd Mtg. (DRIP-3)
Yokohama (Japan)
Contact: Prof. T. Ogawa,
Gakushuin Univ., Dept. of
Physics, 1-5-1 Mejiro,
Toshima-ku, Tokyo 171, Japan

17-22 **Optics and Optical Engineering**,
Cambridge Symp.
Cambridge (USA)
Contact: Soc. of Photo-Optical
Instrumentation Eng. (SPIE),
P.O. Box 10, Bellingham
WA 98227, USA